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POSITIVE DEVELOPER AR46 bottle 1 litre

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CHARACTERISTICS

Positive developer for PCB presensibilized CIF. 1 litre ready for use.

DEVELOPMENT

Prepare the development in a tray Pour the contents of CIF AR46 in the tray, use at at 18° minimum. Immediately after exposure, put the PCB into the developer and shake. The photosensitive resin which has been exposed should disappear in less than 2 minutes. If development has not been totally carried out, please refer to the table at the end of the notice).

If the plate is not immediately etched, rinse it with running water.

SECURITY

Report to the MDS, available on simple request.

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	INCIDENT AND SOLUTION TABLE	
INCIDENTS	CAUSES	SOLUTIONS
Photo sensitive circuit	Exposure time too short	Carry out test with grey
Development is not made	Out of date plate.	scale (test film) and a new
	Development	<u>developer – Minimum</u>
	temperature too low -	temperature 18°C
	saturated developer.	
Circuit cut during	Bad contact of original	Improve pressing or check
development or out of	on the plate - Mylar too	the machine – Make a
focus development	thick - Drawing density	contact film (C.I.F.
	<u>not black enough – cut</u>	<u>reprophane film) . Check</u>
	on the drawing	light table.
Copper full of holes after	Over exposed plate -	Check the original and
etching	drawing not opaque	make test with grey scale
	enough – bad contact –	<u>(test film)</u>
	etching time too long	
No etching	Resin remains on the	Increase exposure and
	plate. Saturated etching	<u>development times –</u>
	<u>agent</u>	change etching agent.
Fine tracks after etching	U.V. pass under the	Improve contact. Improve
	<u>original – under etching</u>	<u>etching system – Make a</u>
	<u>phenomenon – Mylar</u>	<u>contact film – Place the</u>
	too thick	photo layer against the
		<u>resin</u>

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